



TRISIL™ FOR TELECOM EQUIPMENT PROTECTION

FEATURES

- Bidirectional crowbar protection
- Voltage range from 8V to 400V
- Low capacitance from 20pF to 45pF @ 50V
- Low leakage current : $I_R = 2\mu A$ max
- Holding current: $I_H = 150$ mA min
- Repetitive peak pulse current:
 $I_{PP} = 100$ A (10/1000 μs)

MAIN APPLICATIONS

Any sensitive equipment requiring protection against lightning strikes and power crossing. These devices are dedicated to central office protection as they comply with the most stressfull standards.

Their Low Capacitances make them suitable for ADSL.

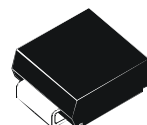
DESCRIPTION

The SMP100LC is a series of low capacitance transient surge arrestors designed for the protection of high debit rate communication equipment. Its low capacitance avoids any distortion of the signal and is compatible with digital transmission line cards (xDSL, ISDN...).

SMP100LC series tested and confirmed compatible with Cooper Bussmann Telecom Circuit Protector TCP 1.25A.

BENEFITS

Trisils are not subject to ageing and provide a fail safe mode in short circuit for a better protection. They are used to help equipment to meet main standards such as UL60950, IEC950 / CSA C22.2 and UL1459. They have UL94 V0 approved resin. SMB package is JEDEC registered (DO-214AA). Trisils comply with the following standards GR-1089 Core, ITU-T-K20/K21, VDE0433, VDE0878, IEC61000-4-5 and FCC part 68.

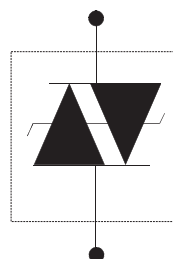


SMB
(JEDEC DO-214AA)

Table 1: Order Codes

| Part Number | Marking |
|--------------|---------|
| SMP100LC-8 | PL8 |
| SMP100LC-25 | L25 |
| SMP100LC-35 | L35 |
| SMP100LC-65 | L06 |
| SMP100LC-90 | L09 |
| SMP100LC-120 | L12 |
| SMP100LC-140 | L14 |
| SMP100LC-160 | L16 |
| SMP100LC-200 | L20 |
| SMP100LC-230 | L23 |
| SMP100LC-270 | L27 |
| SMP100LC-320 | L32 |
| SMP100LC-360 | L36 |
| SMP100LC-400 | L40 |

Figure 1: Schematic Diagram



SMP100LC

Table 2: In compliance with the following standards

| STANDARD | Peak Surge Voltage (V) | Waveform Voltage | Required peak current (A) | Current waveform | Minimum serial resistor to meet standard (Ω) |
|--|------------------------|----------------------------------|--|----------------------------------|---|
| GR-1089 Core First level | 2500 1000 | 2/10 μ s 10/1000 μ s | 500 100 | 2/10 μ s 10/1000 μ s | 0 0 |
| GR-1089 Core Second level | 5000 | 2/10 μ s | 500 | 2/10 μ s | 0 |
| GR-1089 Core Intra-building | 1500 | 2/10 μ s | 100 | 2/10 μ s | 0 |
| ITU-T-K20/K21 | 6000 1500 | 10/700 μ s | 150 37.5 | 5/310 μ s | 0 0 |
| ITU-T-K20 (IEC61000-4-2) | 8000 15000 | 1/60 ns | ESD contact discharge ESD air discharge | | 0 0 |
| VDE0433 | 4000 2000 | 10/700 μ s | 100 50 | 5/310 μ s | 0 0 |
| VDE0878 | 4000 2000 | 1.2/50 μ s | 100 50 | 1/20 μ s | 0 0 |
| IEC61000-4-5 | 4000 4000 | 10/700 μ s 1.2/50 μ s | 100 100 | 5/310 μ s 8/20 μ s | 0 0 |
| FCC Part 68, lightning surge type A | 1500 800 | 10/160 μ s 10/560 μ s | 200 100 | 10/160 μ s 10/560 μ s | 0 0 |
| FCC Part 68, lightning surge type B | 1000 | 9/720 μ s | 25 | 5/320 μ s | 0 |

Table 3: Absolute Ratings ($T_{amb} = 25^{\circ}\text{C}$)

| Symbol | Parameter | | Value | Unit |
|--------------------|---|--|---|--------------------|
| I_{PP} | Repetitive peak pulse current (see figure 2) | 10/1000 μ s 8/20 μ s 10/560 μ s 5/310 μ s 10/160 μ s 1/20 μ s 2/10 μ s | 100 400 140 150 200 400 500 | A |
| I_{FS} | Fail-safe mode : maximum current (note 1) | 8/20 μ s | 5 | kA |
| I_{TSM} | Non repetitive surge peak on-state current (sinusoidal) | t = 0.2 s t = 1 s t = 2 s t = 15 mn | 24 15 12 4 | A |
| I^2t | I^2t value for fusing | t = 16.6 ms t = 20 ms | 20 21 | A ² s |
| T_{stg} T_j | Storage temperature range Maximum junction temperature | | -55 to 150 150 | $^{\circ}\text{C}$ |
| T_L | Maximum lead temperature for soldering during 10 s. | | 260 | $^{\circ}\text{C}$ |

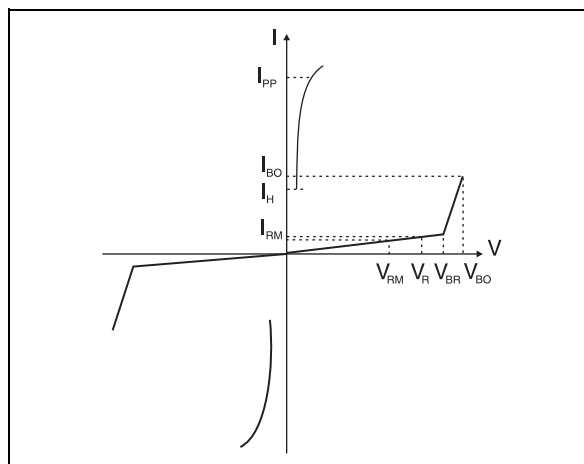
Note 1: in fail safe mode, the device acts as a short circuit

Table 4: Thermal Resistances

| Symbol | Parameter | Value | Unit |
|---------------|--|-------|------|
| $R_{th(j-a)}$ | Junction to ambient (with recommended footprint) | 100 | °C/W |
| $R_{th(j-l)}$ | Junction to leads | 20 | °C/W |

Table 5: Electrical Characteristics ($T_{amb} = 25^{\circ}\text{C}$)

| Symbol | Parameter |
|----------|----------------------------|
| V_{RM} | Stand-off voltage |
| V_{BR} | Breakdown voltage |
| V_{BO} | Breakover voltage |
| I_{RM} | Leakage current |
| I_{PP} | Peak pulse current |
| I_{BO} | Breakover current |
| I_H | Holding current |
| V_R | Continuous reverse voltage |
| I_R | Leakage current at V_R |
| C | Capacitance |



| Types | $I_{RM} @ V_{RM}$ | | $I_R @ V_R$ | | Dynamic V_{BO} | Static $V_{BO} @ I_{BO}$ | | I_H | C | C |
|--------------|-------------------|-----|---------------|-----|------------------|--------------------------|------|-----------|--------|--------|
| | max. | | max. | | max. | max. | max. | min. | typ. | typ. |
| | μA | V | μA | V | V | V | mA | note 4 | note 5 | note 6 |
| SMP100LC-8 | 2 | 6 | 5 | 8 | 25 | 15 | 800 | 50 (typ.) | NA | 75 |
| SMP100LC-25 | | 22 | | 25 | 40 | 35 | | 150 | NA | 65 |
| SMP100LC-35 | | 32 | | 35 | 55 | 55 | | | NA | 55 |
| SMP100LC-65 | | 55 | | 65 | 85 | 85 | | | 45 | 90 |
| SMP100LC-90 | | 81 | | 90 | 120 | 125 | | | 40 | 80 |
| SMP100LC-120 | | 108 | | 120 | 155 | 160 | | | 35 | 75 |
| SMP100LC-140 | | 120 | | 140 | 185 | 190 | | | 30 | 65 |
| SMP100LC-160 | | 144 | | 160 | 205 | 200 | | | 30 | 65 |
| SMP100LC-200 | | 180 | | 200 | 255 | 250 | | | 30 | 60 |
| SMP100LC-230 | | 207 | | 230 | 295 | 285 | | | 30 | 60 |
| SMP100LC-270 | | 243 | | 270 | 345 | 335 | | | 30 | 60 |
| SMP100LC-320 | | 290 | | 320 | 400 | 390 | | | 25 | 50 |
| SMP100LC-360 | | 325 | | 360 | 460 | 450 | | | 25 | 50 |
| SMP100LC-400 | | 360 | | 400 | 540 | 530 | | | 20 | 45 |

Note 1: I_R measured at V_R guarantee $V_{BR} \min \geq V_R$

Note 2: see functional test circuit 1

Note 3: see test circuit 2

Note 4: see functional holding current test circuit 3

Note 5: $V_R = 50\text{V}$ bias, $V_{RMS}=1\text{V}$, $F=1\text{MHz}$

Note 6: $V_R = 2\text{V}$ bias, $V_{RMS}=1\text{V}$, $F=1\text{MHz}$

Figure 2: Pulse waveform

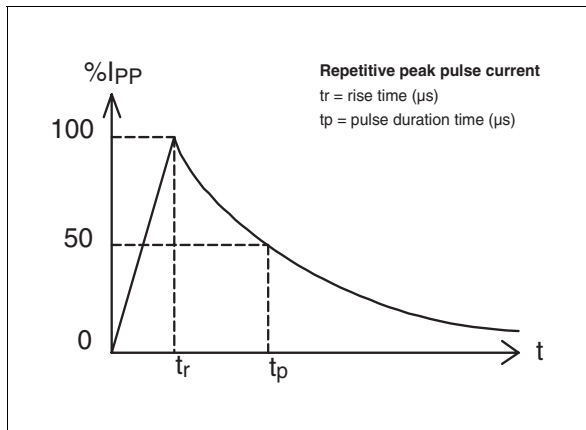


Figure 3: Non repetitive surge peak on-state current versus overload duration

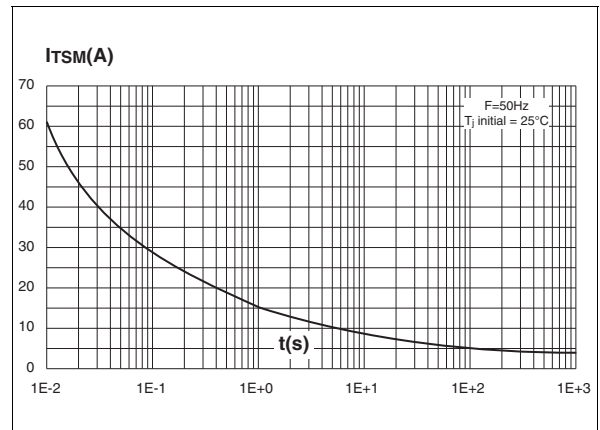


Figure 4: On-state voltage versus on-state current (typical values)

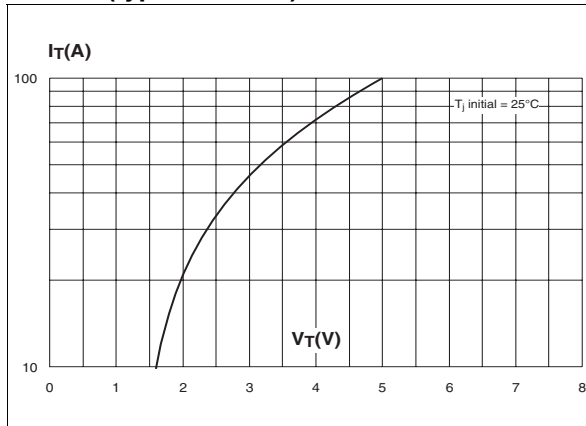


Figure 5: Relative variation of holding current versus junction temperature

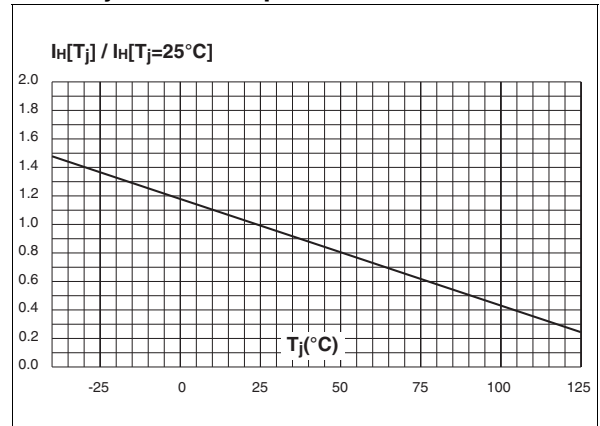


Figure 6: Relative variation of breakover voltage versus junction temperature

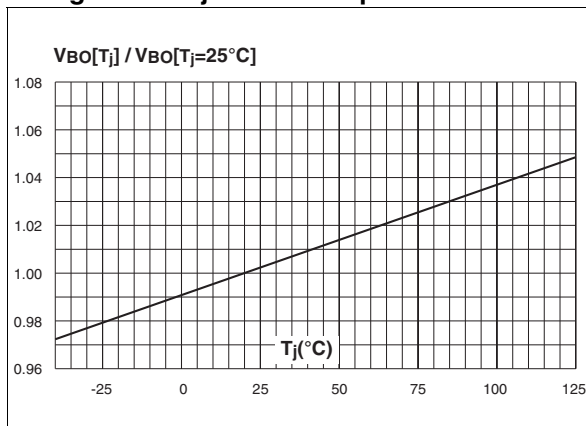


Figure 7: Relative variation of leakage current versus junction temperature (typical values)

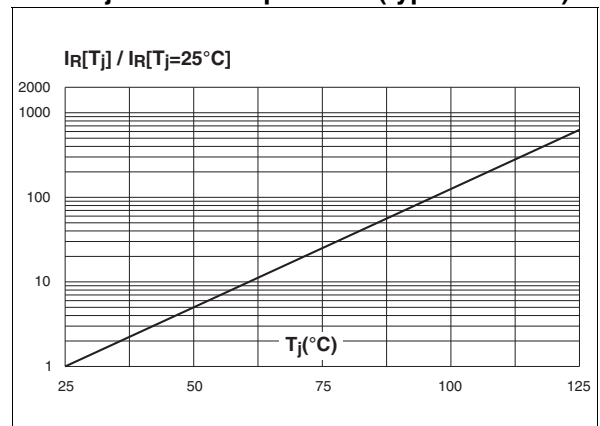


Figure 8: Variation of thermal impedance junction to ambient versus pulse duration (Printed circuit board FR4, SCu=35µm, recommended pad layout)

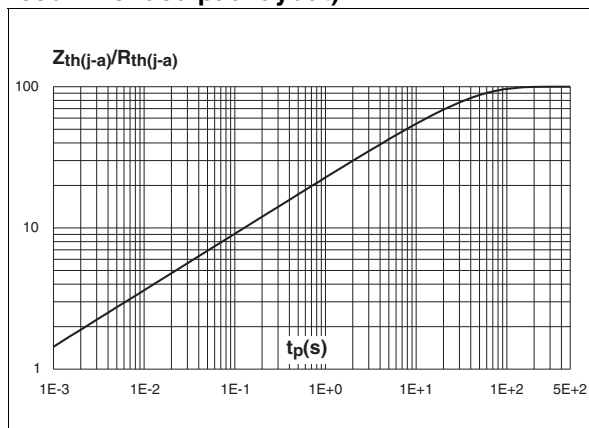
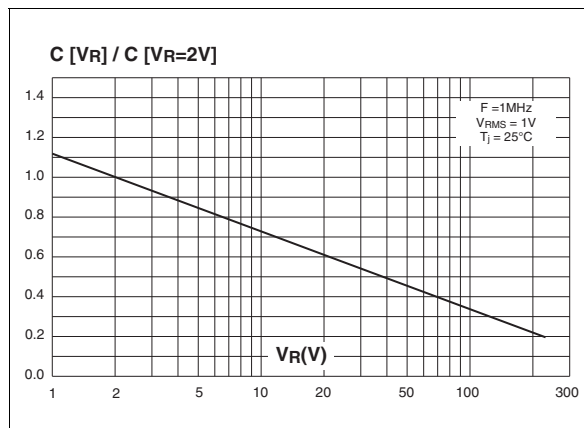
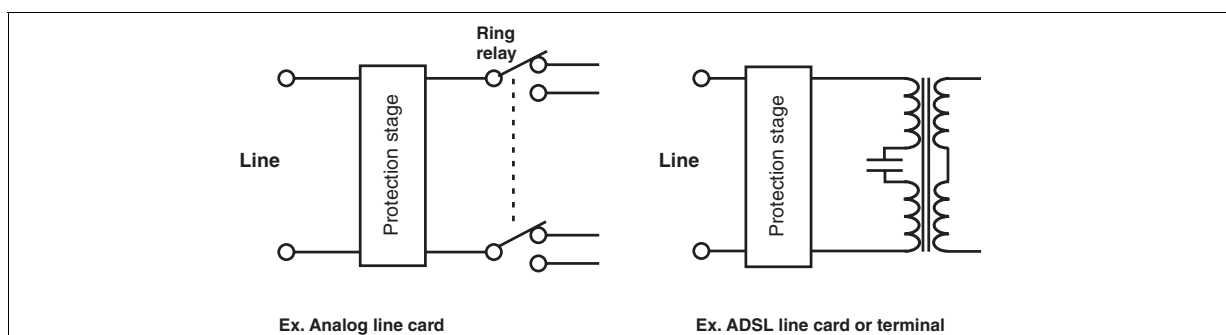


Figure 9: Relative variation of junction capacitance versus reverse voltage applied (typical values)

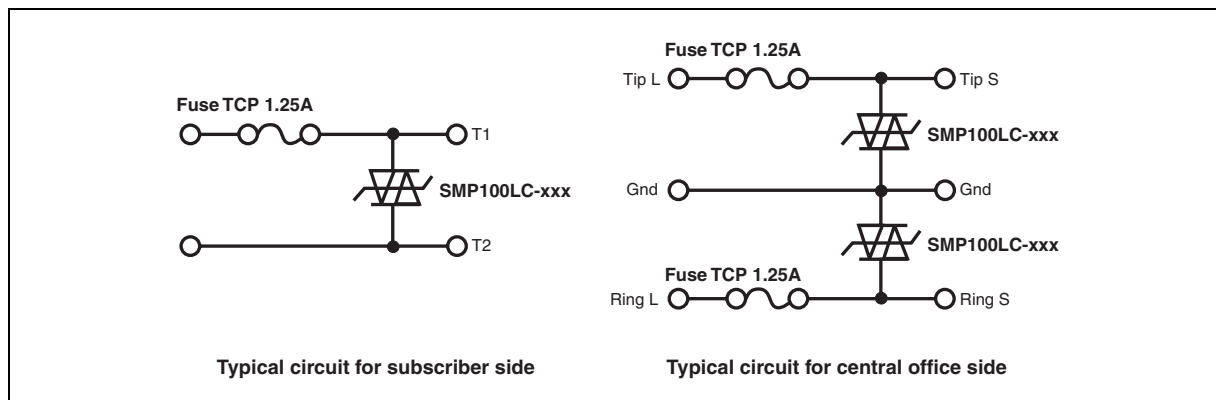


APPLICATION NOTE

In wireline applications, analog or digital, both central office and subscriber sides have to be protected. This function is assumed by a combined series / parallel protection stage.

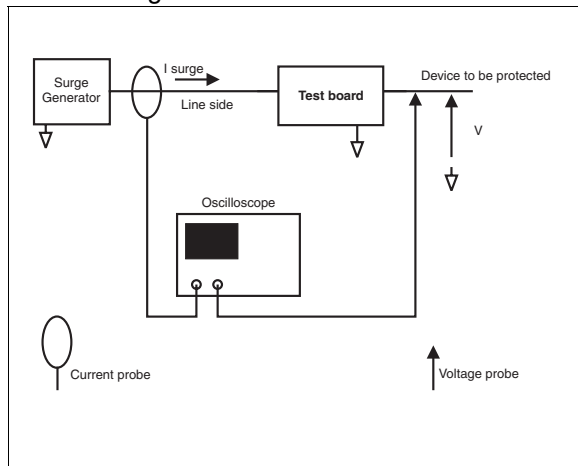


In such a stage, parallel function is assumed by one or several Trisil, and is used to protect against short duration surge (lightning). During this kind of surges the Trisil limits the voltage across the device to be protected at its break over value and then fires. The fuse assumes the series function, and is used to protect the module against long duration or very high current mains disturbances (50/60Hz). It acts by safe circuits opening. Lightning surge and mains disturbance surges are defined by standards like GR1089, FCC part 68, ITU-T K20.



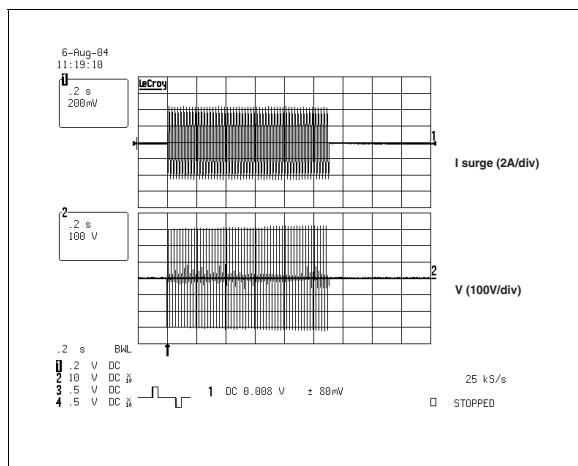
SMP100LC

Following figure shows the test method of the board having Fuse and Trisil.



These topologies, using SMP100LC from ST and TCP1.25A from Cooper Bussmann, have been functionally validated with a Trisil glued on the PCB. Following example was performed with SMP100LC-270 Trisil. For more information, see Application Note AN2064.

Following curve shows Trisil action while the fuse remains operational.



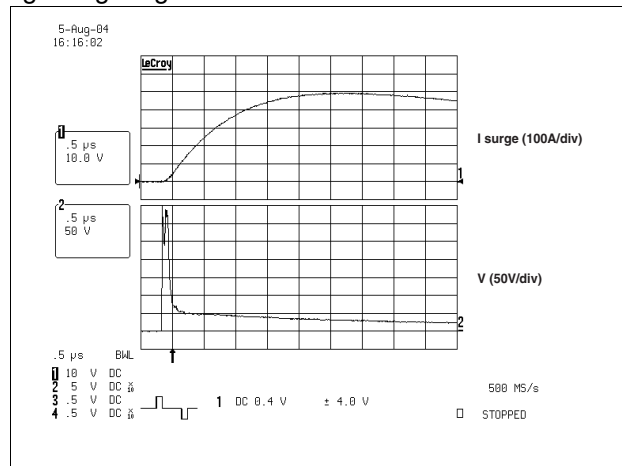
Test conditions:

600V 3A 1.1s (first level), $T_{amb} = 25^{\circ}\text{C}$

Test result:

Fuse and Trisil OK after test in accordance with GR1089 requirements

Following curve shows the turn on of the Trisil during lightning surge.



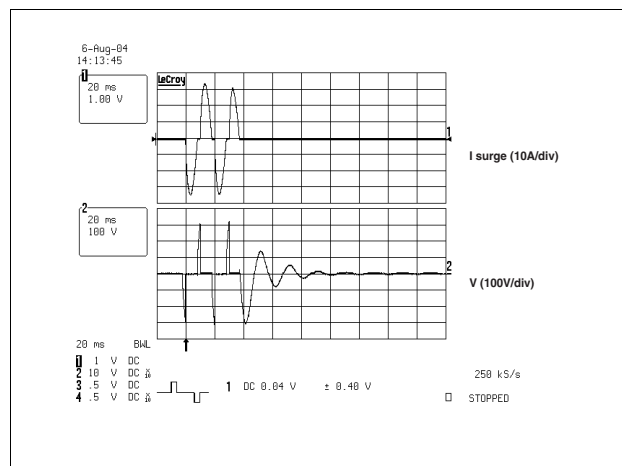
Test conditions:

2/10μs + and -2.5 and 5kV 500A (10 pulses of each polarity), $T_{amb} = 25^{\circ}\text{C}$

Test result:

Fuse and Trisil OK after test in accordance with GR1089 requirements

In case of high current power cross test, the fuse acts like a switch by opening the circuit.



Test conditions:

277V 25A (second level), $T_{amb} = 25^{\circ}\text{C}$

Test result:

Fuse safety opened and Trisil OK after test in accordance with GR1089 requirements

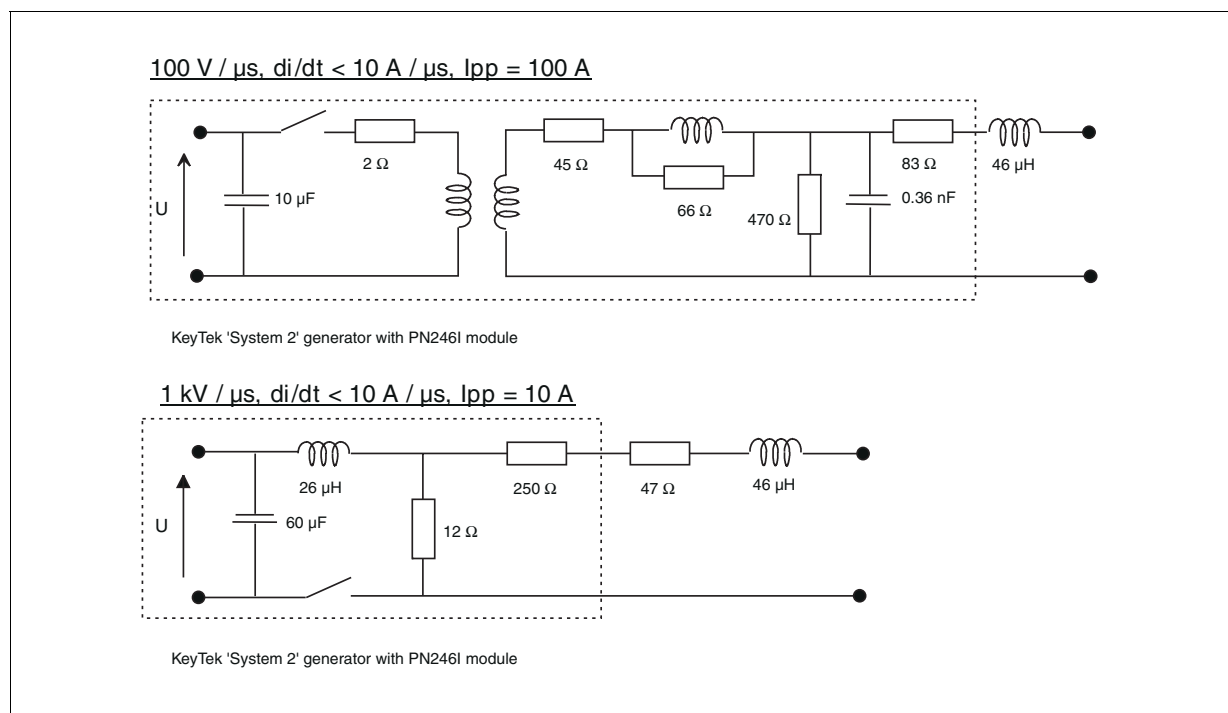
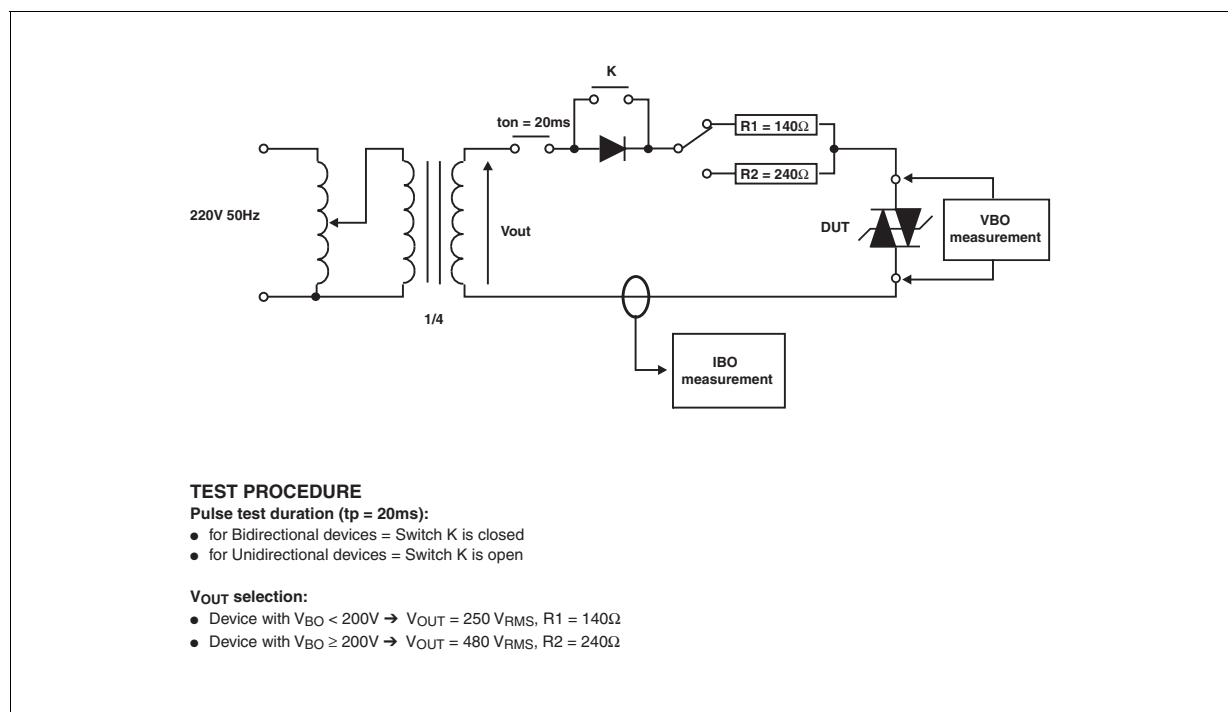
Figure 10: Test circuit 1 for Dynamic I_{BO} and V_{BO} parametersFigure 11: Test circuit 2 for I_{BO} and V_{BO} parameters

Figure 12: Test circuit 3 for dynamic I_H parameter

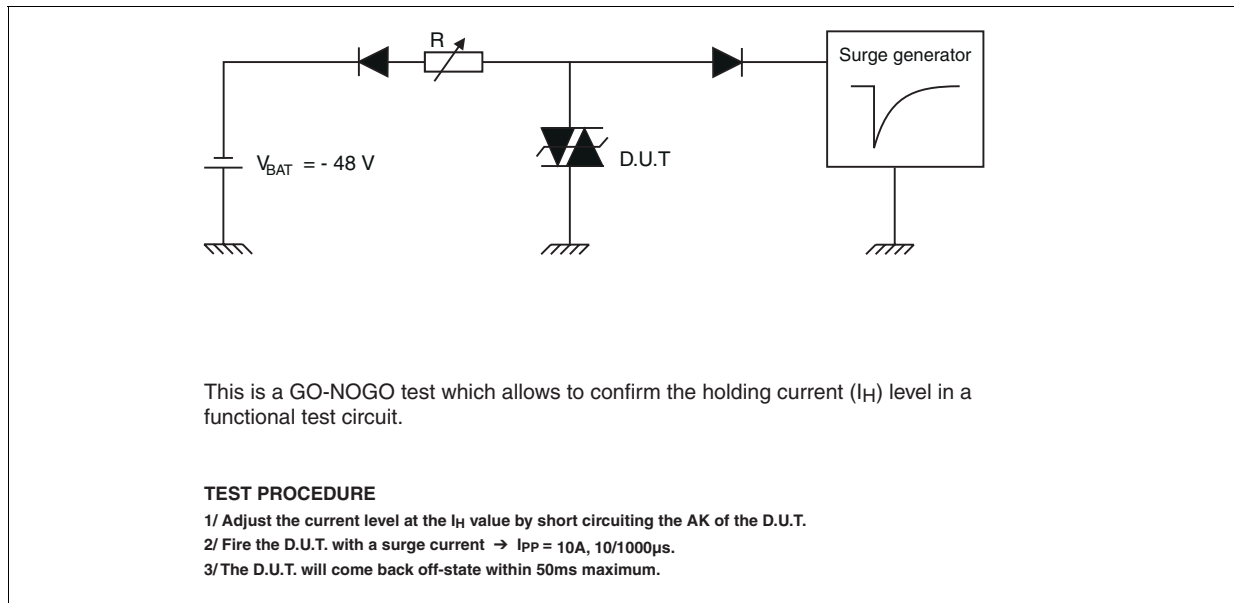


Figure 13: Ordering Information Scheme

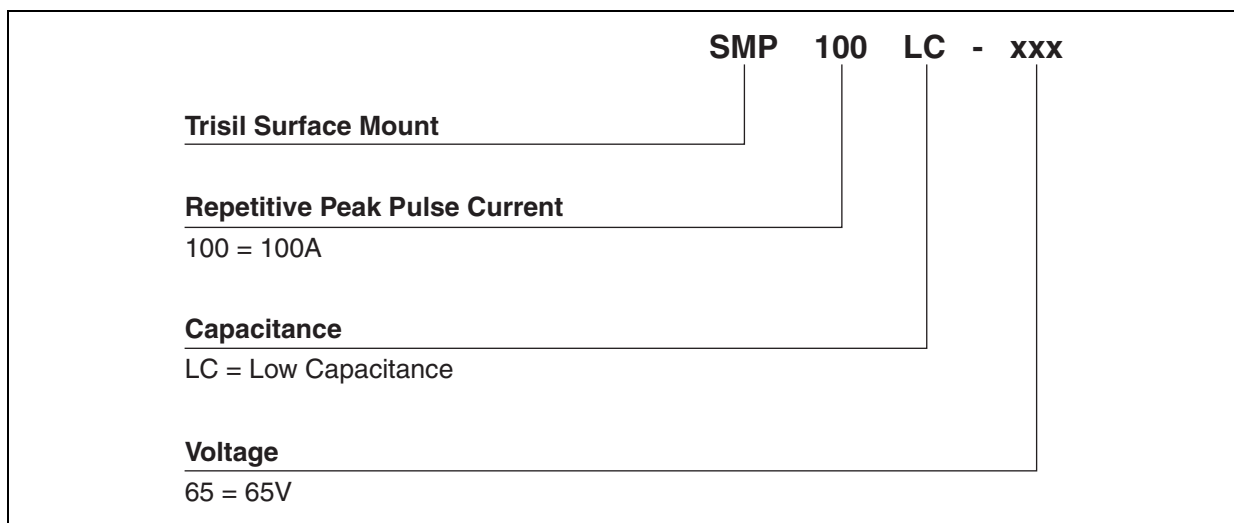


Figure 14: SMB Package Mechanical data

| REF. | DIMENSIONS | | | |
|------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.075 | 0.096 |
| A2 | 0.05 | 0.20 | 0.002 | 0.008 |
| b | 1.95 | 2.20 | 0.077 | 0.087 |
| c | 0.15 | 0.41 | 0.006 | 0.016 |
| E | 5.10 | 5.60 | 0.201 | 0.220 |
| E1 | 4.05 | 4.60 | 0.159 | 0.181 |
| D | 3.30 | 3.95 | 0.130 | 0.156 |
| L | 0.75 | 1.60 | 0.030 | 0.063 |

Figure 15: Foot Print Dimensions (in millimeters)

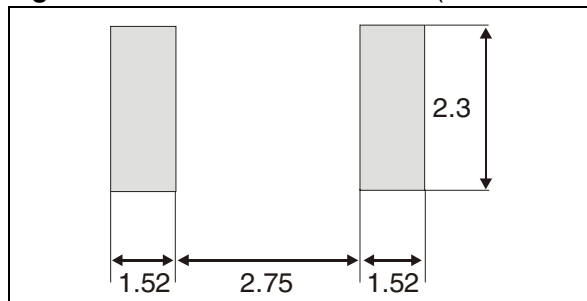


Table 6: Ordering Information

| Part Number | Marking | Package | Weight | Base qty | Delivery mode |
|--------------|---------|---------|--------|----------|---------------|
| SMP100LC-8 | PL8 | SMB | 0.11 g | 2500 | Tape & reel |
| SMP100LC-25 | L25 | | | | |
| SMP100LC-35 | L35 | | | | |
| SMP100LC-65 | L06 | | | | |
| SMP100LC-90 | L09 | | | | |
| SMP100LC-120 | L12 | | | | |
| SMP100LC-140 | L14 | | | | |
| SMP100LC-160 | L16 | | | | |
| SMP100LC-200 | L20 | | | | |
| SMP100LC-230 | L23 | | | | |
| SMP100LC-270 | L27 | | | | |
| SMP100LC-320 | L32 | | | | |
| SMP100LC-360 | L36 | | | | |
| SMP100LC-400 | L40 | | | | |

Table 7: Revision History

| Date | Revision | Description of Changes |
|-------------|----------|---|
| 09-Nov-2004 | 9 | Absolute ratings values, table 3 on page 2, updated. |
| 07-Dec-2004 | 10 | SMP100LC-320, SMP100LC-360 and SMP100LC-400 addition. |
| 20-Jun-2005 | 11 | Telecom Circuit Protector added |

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